



DIGITAL DATA NETWORKS PRODUCT PORTFOLIO

TE Connectivity (TE) offers a diverse and comprehensive product portfolio to support your connectivity needs. TE helps shape the connected future through collaborating with customers and ecosystem partners while pioneering new technologies. Our products can support the market needs for higher speeds, energy efficiency, and miniaturization in Al/cloud, edge, and endpoint markets. TE's manufacturing, value-added support and investments are focused on delivering top quality, highly efficient wired and wireless products to address dynamic design cycles.

TE offers a broad range of products which can be used across many industries, providing extensive options for customers and the opportunity to consolidate their supplier base. Our engineering and manufacturing expertise, combined with our global footprint allows us to deliver one of the largest connectivity and sensor product portfolios.

WIRE-TO-BOARD



AMP CT CONNECTORS



0.8MM LOW PROFILE IDC



HIGH CURRENT INTERCONNECT (HCI)



AMP MINI CT CONNECTORS



ECONOMY INTERCONNECTION SERIES (EIS)



HIGH PERFORMANCE INTERCONNECT (HPI) CONNECTORS



AMP MICRO CT CONNECTORS



FLAT FLEXIBLECABLE (FFC)CONNECTORS



AMP-LATCH RIBBON CABLE INTERCONNECTS



FLEXIBLE PRINTED CIRCUIT (FPC) CONNECTORS



BOARD-TO-BOARD



CHAMP DOCKING **CONNECTORS**



FINE PITCH BOARD-TO-BOARD **CONNECTORS**





COMPRESSIVE **CONNECTORS**



FREE HEIGHT **CONNECTORS**



STRADA WHISPER BACKPLANE **CONNECTORS**



EUROCARD **CONNECTORS**



IMPACT BACKPLANE **CONNECTORS**



Z-PACK BACKPLANE **CONNECTORS**



ERNI DIN/ERMET **CONNECTORS**



MICTOR **CONNECTORS**







MEMORY CARD CONNECTORS



<u>USB</u> **CONNECTORS**



MODULAR JACKS <u>& PLUGS</u>





AMPLIMITE D-SUBMINIATURE **CONNECTORS**



SATA & MICRO SATA **CONNECTORS**





SIM CARD **CONNECTORS**

HIGH SPEED I/O



ACTIVE OPTICAL CABLE ASSEMBLIES



ELSFP (EXTERNAL LASER SMALL FORM-FACTOR PLUGGABLE) PORTFOLIO



QSFP. QSFP+, & ZQSFP+ PORTFOLIO



SLIMSAS & SLIMSAS LP PORTFOLIO



ADRENALINE 224G PRODUCT PORTFOLIO



MCIO (MINI COOL EDGE I/O) PORTFOLIO



<u>QSFP-DD</u> PORTFOLIO



SLIVER CABLED INTERCONNECT SYSTEM



<u>CDFP</u> <u>PORTFOLIO</u>



M-XIO (MODULAR EXTENSIBLE I/O) PORTFOLIO



SAS AND MINI-SAS SCSI CONNECTORS



XFP PORTFOLIO



<u>CFP, CFP2 & CFP4</u> <u>PORTFOLIO</u>



<u>OSFP</u> PORTFOLIO



SFP, SFP+ & ZSFP PORTFOLIO



HIGH SPEED BACKPLANE CONNECTORS



SOCKETS



LAND GRID ARRAY (LGA)
PROCESSOR SOCKETS
AND HARDWARE



DUAL IN-LINE PACKAGE (DIP) SWITCH SOCKETS



PIN GRID ARRAY (PGA) PROCESSOR SOCKETS AND HARDWARE



MEMORY SOCKETS



HEAT SINKS



SINGLE IN-LINE PACKAGE (SIP) SWITCH SOCKETS

ANTENNAS



RF PRODUCTS



RF CONNECTORS

POWER



BATTERY CONNECTORS
<u>& HOLDERS</u>



ELCON DRAWER



MULTI-BEAM XL, MULTI-BEAM XLE, AND MULTI-BEAM HD CONNECTORS



RF MODULES

BUSBAR CONNECTORS



HIGH DENSITY CARD EDGE POWER CONNECTORS



OPEN COMPUTE PROJECT COMPATIBLE POWER SOLUTIONS



RF TERMINATORS



RF CABLE ASSEMBLIES



DC JACK BATTERY CONNECTORS



ICCON HIGH POWER BLOCK & INSERT, PIN AND SOCKET



RAPID LOCK POWER CONNECTORS



ELCON CONNECTORS



MOBILE BATTERY CONNECTORS



WAVE CRIMP FLAT COPPER POWER CONNECTORS



CABLE ASSEMBLIES



te.com

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